



80V +175°C N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

Product Summary

BV _{DSS}	Rds(on)	I _D T _C = +25°C
901/	7.8mΩ @ V _{GS} = 10V	91A
80V	11mΩ @ V _{GS} = 4.5V	77A

Features

- Rated to +175°C Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switching (UIS) Test in Production Ensures More Reliable and Robust End Application
- High-Conversion Efficiency
- Low Rds(ON) Minimizes On-State Losses
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- An automotive-compliant part is available under separate datasheet (<u>DMTH8008LPSWQ</u>)

Description and Applications

This new generation MOSFET is designed to minimize $R_{DS(ON)}$ yet maintain superior switching performance. This device is ideal for use in power management and load switches.

- DC-DC converters
- Load switches

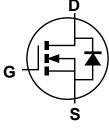
Mechanical Data

- Package: PowerDI[®]5060-8
- Package Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram Below
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 (§3)
- Weight: 0.097 grams (Approximate)

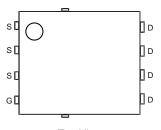




Bottom View



Internal Schematic



Top View Pin Configuration

Ordering Information (Note 4)

Orderable Part Number	Paakaga	Packing		
Orderable Part Number	Package	Qty.	Carrier	
DMTH8008LPSW-13	PowerDI5060-8/SWP (Type UX)	2,500	Tape & Reel	

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information

PowerDI5060-8/SWP (Type UX)

D D D D

TH8008LS

YY WW

S S S G

) | |= Manufacturer's Marking TH8008LS = Product Type Marking Code YYWW = Date Code Marking YY = Year (ex: 24 = 2024) WW = Week (01 to 53)



Maximum Ratings (@T_C = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage			VDSS	80	V
Gate-Source Voltage	Vgss	±20	V		
Continuous Drain Current, V _{GS} = 10V (Note 5)	lo	91 64	А		
Maximum Continuous Body Diode Forward Current (Is	69	Α		
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	Ірм	360	Α		
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle = 1%)			Ism	360	Α
Avalanche Current, L = 0.1mH (Note 6)			las	23	Α
Avalanche Energy, L = 0.1mH (Note 6)			Eas	26.5	mJ

Thermal Characteristics (@Tc = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 7)	T _A = +25°C	PD	1.5	W
Thermal Resistance, Junction to Ambient (Note 7)	Steady State	Reja	99	°C/W
Total Power Dissipation (Note 8)	T _A = +25°C	P _D	3	W
Thermal Resistance, Junction to Ambient (Note 8)	Steady State	Reja	45	°C/W
Total Power Dissipation (Note 5)	Tc = +25°C	PD	100	W
Thermal Resistance, Junction to Case (Note 5)		Rejc	1.5	°C/W
Operating and Storage Temperature Range		T _J , T _{STG}	-55 to +175	°C

Notes:

- 5. Thermal resistance from junction to soldering point (on the exposed drain pad).
- 6. I_{AS} and E_{AS} ratings are based on low frequency and duty cycles to keep $T_J = +25$ °C.
- 7. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.
- 8. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.



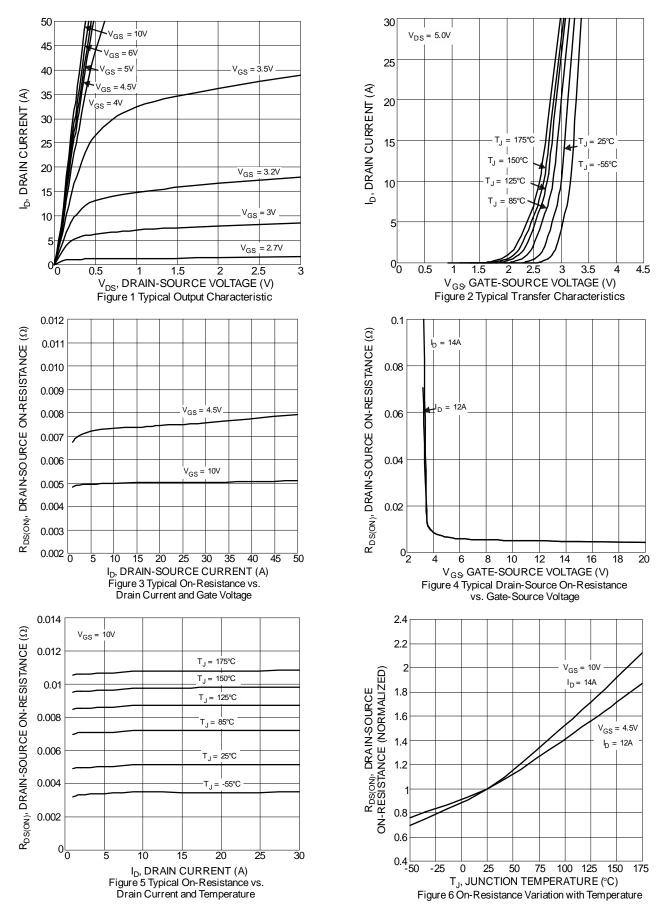
Electrical Characteristics (@ $T_C = +25$ °C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 9)							
Drain-Source Breakdown Voltage	BV _{DSS}	80	_	_	V	$V_{GS} = 0V$, $I_{D} = 1mA$	
Zero Gate Voltage Drain Current	I _{DSS}	_	_	1	μA	V _{DS} = 64V, V _{GS} = 0V	
Gate-Source Leakage	Igss	_	_	±100	nA	$V_{GS} = \pm 20V$, $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 9)							
Gate Threshold Voltage	VGS(TH)	1.3	_	2.8	V	V _{DS} = V _{GS} , I _D = 1mA	
Static Drain-Source On-Resistance	D	_	5	7.8	mΩ	VGS = 10V, ID = 14A	
Static Drain-Source On-Resistance	RDS(ON)	_	8	11	11122	V _G S = 4.5V, I _D = 12A	
Diode Forward Voltage	VsD	_	0.8	1.2	V	VGS = 0V, IS = 14A	
DYNAMIC CHARACTERISTICS (Note 10)							
Input Capacitance	C _{iss}	_	2345	_		V _{DS} = 40V, V _{GS} = 0V f = 1MHz	
Output Capacitance	Coss	_	842	_	pF		
Reverse Transfer Capacitance	Crss	_	51.9	_			
Gate Resistance	Rg	_	1.7	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (VGS = 4.5V)	Qg	_	21.7	_			
Total Gate Charge (VGS = 10V)	Qg	_	41.2	_	nC	V _{DD} = 40V, I _D = 2A	
Gate-Source Charge	Qgs	_	5.0	_	nc nc		
Gate-Drain Charge	Qgd	_	10.6	_			
Turn-On Delay Time	t _{D(ON)}	_	5.8	_		$V_{DD} = 40V, V_{GS} = 10V$ $I_{D} = 2A, R_{g} = 1.6\Omega$	
Turn-On Rise Time	t _R	_	5.4	_			
Turn-Off Delay Time	tD(OFF)	_	24.5	_	ns		
Turn-Off Fall Time	t _F	_	43.2	_			
Body Diode Reverse Recovery Time	trr	-	61	_	ns	I- 20 dl/dt 4000/	
Body Diode Reverse Recovery Charge	Q _{RR}	_	181	_	nC	IF = 2A, dl/dt = 100A/µs	

Notes:

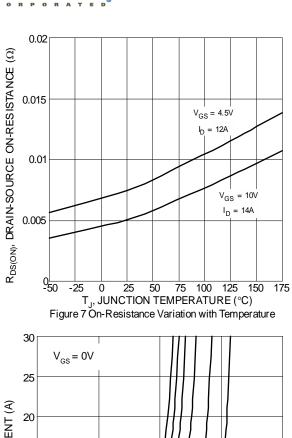
Short duration pulse test used to minimize self-heating effect.
 Guaranteed by design. Not subject to product testing.

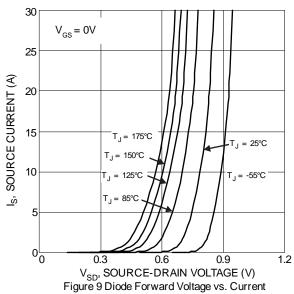


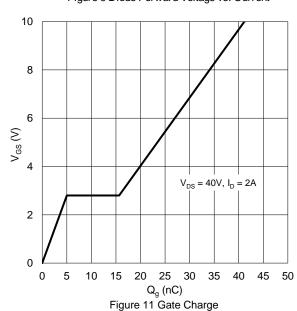












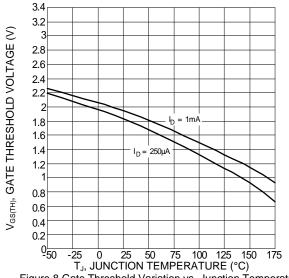
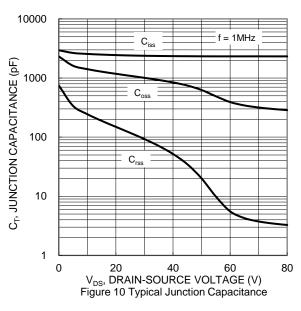
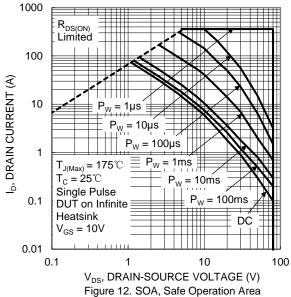
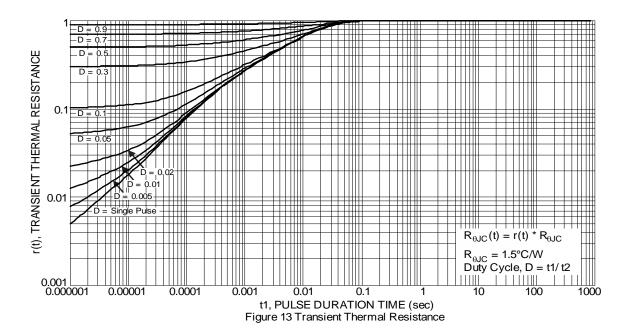


Figure 8 Gate Threshold Variation vs. Junction Temperature







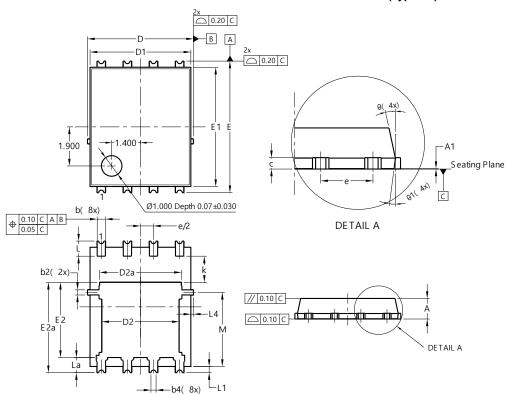




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8/SWP (Type UX)

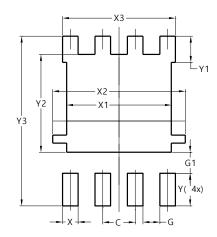


Damar DIFOCO O/CW/D						
PowerDI5060-8/SWP (Type UX)						
Dim	Min	Max	Тур			
Α	0.90	1.10	1.00			
A1	0	0.05				
b	0.30	0.50	0.41			
b2	0.20	0.35	0.25			
b4	C).25REF	-			
С	0.230	0.330	0.277			
D	5	5.15 BSC				
D1	4.70	5.10	4.90			
D2	3.56	3.96	3.76			
D2a	3.78	4.18	3.98			
Е	6	.40 BS0				
E1	5.60	6.00	5.80			
E2	3.46	3.86	3.66			
E2a	4.195	4.595	4.395			
е	1.27BSC					
k	1.05					
L	0.635	0.835	0.735			
La	0.635	0.835	0.735			
L1	0.200	0.400	0.300			
L4	0.025	0.225	0.125			
М	3.205	4.005	3.605			
θ	10°	12°	11°			
θ1	6°	8°	7°			
All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8/SWP (Type UX)



Dimensions	Value (in mm)		
С	1.270		
G	0.660		
G1	0.820		
X	0.610		
X1	4.100 5.190		
X2			
Х3	4.420		
Y	1.270		
Y1	1.020		
Y2	3.810		
Y3	6.610		



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